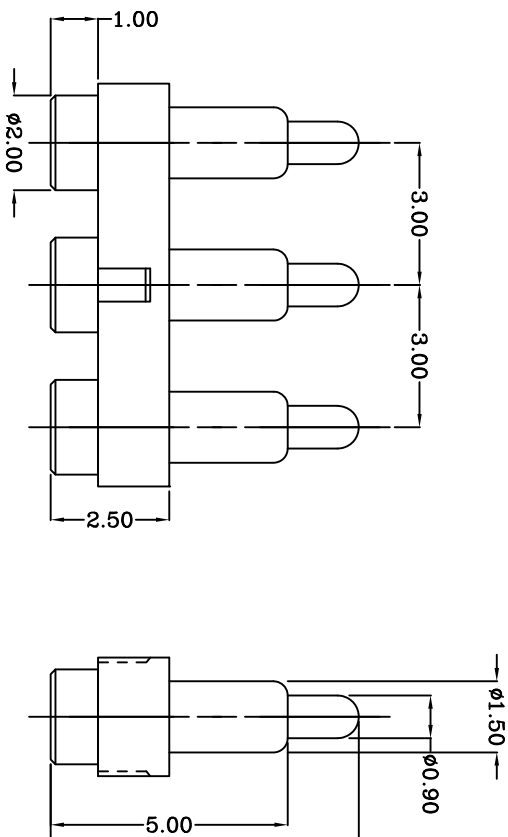
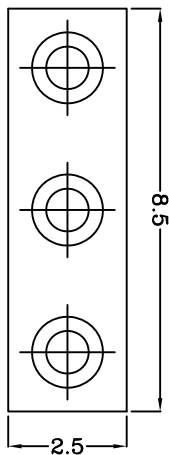
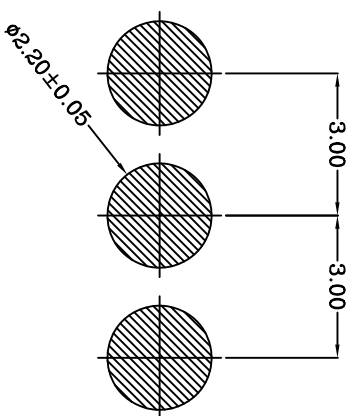


DWG NO.
C-110227



TOP-LINK



Recommended PCB Layout
Recommended solder paste thickness is 0.10 mm

Notes:

1 Material, Housing: PA 4,6 (30% Glass Filled)
Color: Black.

2 Mechanical demands:

Plating Plunger: 0.4um Au over 1.4um Ni
Plating Body: 0.1um Au over 1.4um Ni.

LDC		HANDLE:	LI	NAME	P0GD 3P	PGC-1.5-6.5-R-3P-3.0PH		
-		update remark		SCALE	A4	DWG NO.	C-110227	SHEET 1 OF 1
DIST -		REVISION RECORD	APVD	DATE				REV B
				B007/18/21				
				SURF TEXTURE: 32/ V REMOVE BURRS, BREAK SHARP EDGES R0.05 MAX DO NOT SCALE PRINT				

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED		MATL		HT TR	—	FIN	— 
0	= ±-	DWN		APVD		<i>Top-Link Electronics</i> Top-Link Electronics Ltd.	
0.0	= ±0.15	Benny		Lansing			
0.00	= ±0.10	CHK		REL			
0.000	= ±	Andy					
ANGLE: ±1°							
SURF TEXTURE: 32/ 		NAME POGD 3P					
REMOVE BURRS, BREAK SHARP EDGES R0.05 MAX		PGC-1.5-6.5-R-3P-3.0PH					
DO NOT SCALE PRINT		SCALE	A4	DWG NO.	C-110227	SHEET 1 OF 1	REV B

110227-3
PART NUMBER